imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

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NV4V41SF

Blue-Violet Laser Diode

405 nm Blue-Violet Laser Light Source

DESCRIPTION

The NV4V41SF is a high output blue-violet laser diode with a wavelength of 405 nm. A newly developed LD chip structure achieves a high optical power output of 600 mW (CW).

FEATURES

- High optical output power
- Peak wavelength
- Multi transverse mode (lateral)
- Operating temperature range
- ϕ 5.6 mm CAN package

APPLICATIONS

- Blue-violet laser light source
- Light source for Lser Direct Imaging system
- Light source for industrial manufacturing equipment
- $T_{\rm C} = 0$ to +30°C

 $P_{o} = 600 \text{ mW} @CW$

 $\lambda_p = 400$ to 405 nm



The mark <R> shows major revised points.

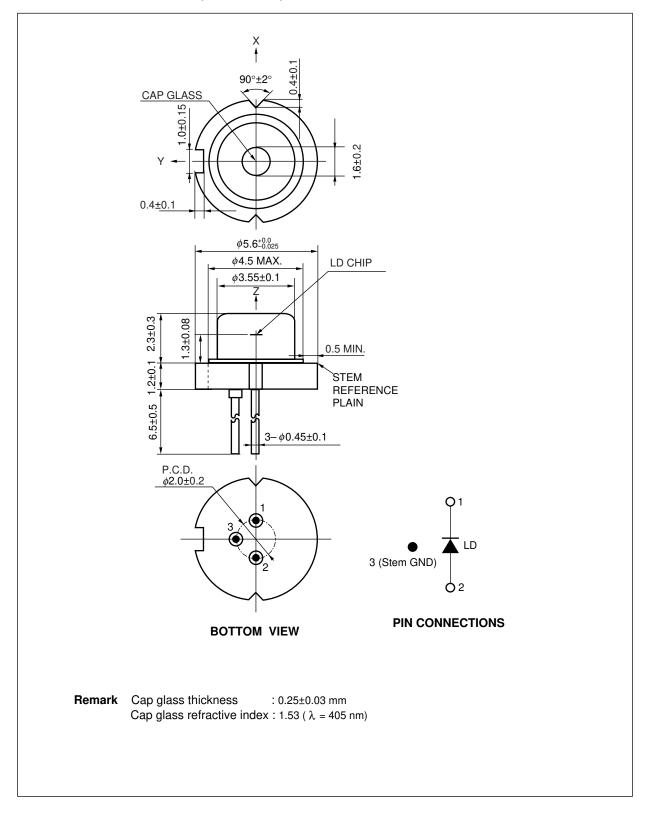
The revised points can be easily searched by copying an "<R>" in the PDF file and specifying it in the "Find what:" field.



Data Sheet

R08DS0064EJ0100 Rev.1.00 Jan 16, 2013

PACKAGE DIMENSIONS (UNIT: mm)



ORDERING INFORMATION

Part Number	Order Number	Rank	Package
NV4V41SF	NV4V41SF-A	HV	Tray Packaging (100 p/Tray)
		KV	Individual Packaging (for small samples)

ABSOLUTE MAXIMUM RATINGS (T_c = 25°C, unless otherwise specified)

Parameter	Symbol	Ratings	Unit
Optical Output Power (CW)	Po	700	mW
Reverse Voltage of LD	V _R	2	V
Operating Case Temperature	Tc	0 to +30	°C
Storage Temperature	T _{stg}	-40 to +85	°C

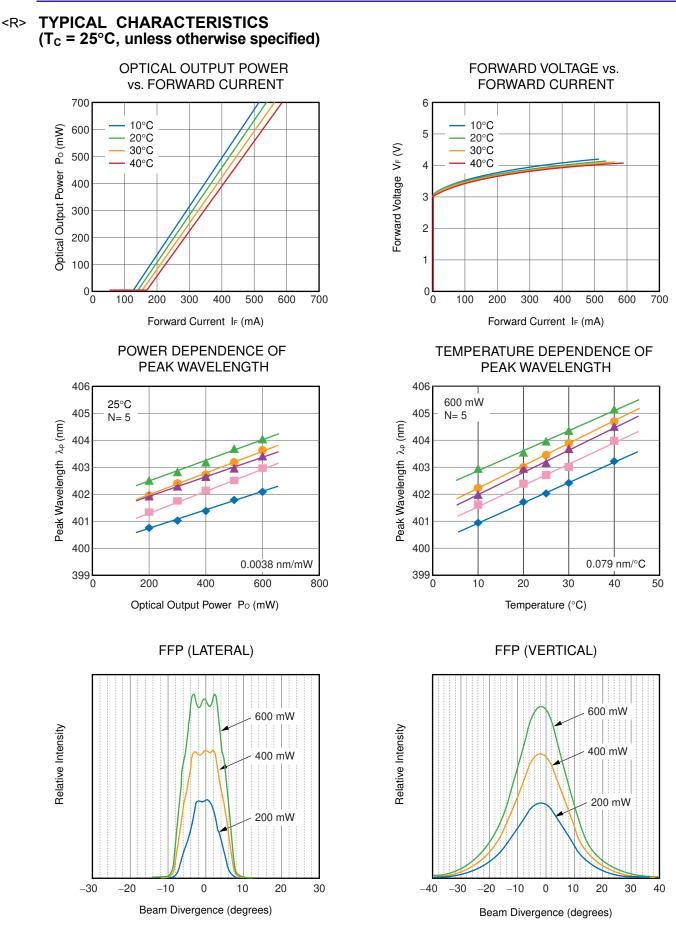
RECOMMENDED OPERATING CONDITIONS ($T_c = 25^{\circ}C$, unless otherwise specified)

Parameter	Symbol	MAX.	Unit
Optical Output Power (CW)	Po	600	mW

ELECTRO-OPTICAL CHARACTERISTICS ($T_c = 25^{\circ}C$, unless otherwise specified)

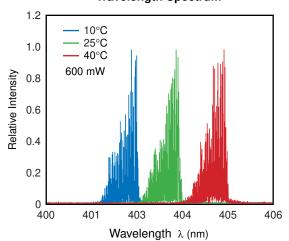
	Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
<r></r>	Threshold Current	I _{th}	CW		140	180	mA
	Operating Current	I _{op}	CW, P _o = 600 mW		500	600	mA
<r></r>	Operating Voltage	V _{op}	CW, P _o = 600 mW		4.1	4.6	V
	Slope Efficiency	η_{d}	CW, P _o = 100 mW, 600 mW	1.0	1.7		W/A
	Peak Wavelength	λρ	CW, P _o = 600 mW	400	Ι	405	nm
	Beam Divergence (lateral)	θ_{ll}	CW, $P_0 = 600 \text{ mW} (1/e^2)$		16	22	deg.
	Beam Divergence (vertical)	$ heta_{\!\!\perp}$	Cvv, F ₀ = 000 mvv (he)	35	40	50	
<r></r>	Position Accuracy Angle (vertical)	$\varDelta heta_{\!\!\perp}$	CW, P _o = 600 mW	-5	_	5	deg.





Remark The graphs indicate nominal characteristics.





Wavelength Spectrum

Remark The graphs indicate nominal characteristics.

NOTES ON HANDLING (UNIT: mm)

- 1. Recommended soldering conditions
 - Peak Temperature $\leq 350^{\circ}$ C
 - Time ≤ 3 seconds
 - Soldering of leads should be made at the point 2.0 mm from the root of the lead
 - This device cannot be mounted using reflow soldering.
- 2. Usage cautions
 - (1) Take the following steps to ensure that the device is not damaged by static electricity.
 - Wear an antistatic wrist strap when soldering the device.
 - We recommend a strap with a 1 M Ω resistor.
 - Make sure that the work table and soldering iron are grounded.
 - Make sure that the soldering iron does not leak.
 - (2) Do not subject the package to undue stress.

The package has a tensile strength of 1N or less. Do not exceed this rating. Also, avoid bending the leads as much as possible. If the leads must be bent, bend them only once, making sure to anchor the stem base of the lead.

- (3) Do not allow the cap glass of the package to become scratched or dirty. Also, do not subject the cap glass to external force.
- (4) Be sure to attach a heat sink to sufficiently dissipate heat.
- (5) Use the device as soon as possible after opening the bag.



SAFETY INFORMATION ON THIS PRODUCT

	VISIBLE LASER RADIATION AVOID EYE OR SKIN EXPOSURE TO DIRECT OR SCATTERED RADIATION OUTPUT POWER 3W MAX WAVELENGTH 400 to 680nm CLASS IV LASER PRODUCT	SEMICONDUCTOR LASER AVOID EXPOSURE-Invisible Laser Radiation is emitted from this aperture	
Warning Laser Beam	 A laser beam is emitted from this diode during operation. If the laser beam or its reflection enters your eye, it may cause injury to the eye or loss of eyesight. (Note that, depending on the wavelength of the beam, the laser beam might not be visible.) Do not look directly into the laser beam. Avoid exposure to the laser beam, any reflected or collimated beam. 		



Revision History

NV4V41SF Data Sheet

		Description		
Rev.	Date	Page	Summary	
0.01	Jul 11, 2012	-	First edition issued	
1.00	Jan 16, 2013	Throughout	This data sheet is officially released (Preliminary Data Sheet becomes Data Sheet).	
		p.3	The typical values of Threshold Current and Operating Voltage are changed in ELECTRO-OPTICAL CHARACTERISTICS.	
			The unit, " $(1/e^2)$ ", is deleted from the value of P ₀ .	
		pp.4,5	TYPICAL CHARACTERISTICS is added.	

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